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DIMD10A

September 2010

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#### **DUAL PRE-BIASED TRANSISTORS FOR POWER MANAGEMENT**

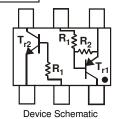
#### **Features**

- Epitaxial Planar Die Construction
- Built-In Biasing Resistors
- One 500mA PNP and One 100mA NPN
- Lead Free/RoHS Compliant (Note 1)
- "Green" Devices (Note 2)
- Qualified to AEC-Q101 Standards for High Reliability

I	Part Numb	Part Number		R2	Marking
	DIMD10A	Tr1	0.1K	10K	C72
	DIMIDITUA	Tr2	10K	_	0/3

### **Mechanical Data**

- Case: SC-74R
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin Finish annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Marking Information: See Table and Page 3
- Ordering Information: See Page 3
- Weight: 0.015 grams (approximate)



### Maximum Ratings PNP Section Tr1 @TA = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Supply Voltage	$V_{CC}$	-50	V
Input Voltage	$V_{IN}$	-5 to +5	V
Output Current	lo	-500	mA

### Maximum Ratings NPN Section Tr2 @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	$V_{CBO}$	50	V
Collector-Emitter Voltage	$V_{\sf CEO}$	50	V
Emitter-Base Voltage	$V_{EBO}$	5	V
Collector Current	lc	100	mA

#### **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation	$P_D$	300*	mW
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

<sup>\*</sup> Not to exceed 200mW for either Tr1 or Tr2.

### Electrical Characteristics PNP Section Tr1 @TA = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Input Voltage	$V_{I(off)}$	-0.3	_	_	V	$V_{CC} = -5V$ , $I_{O} = -100\mu A$
input voitage	$V_{I(on)}$	_	_	-1.5	V	$V_O = 0.3$ , $I_O = -100 \text{mA}$
Output Voltage	V <sub>O(on)</sub>	_	-0.1	-0.3	V	$I_{O} = -100 \text{mA}/-5 \text{mA}$
Input Current	l <sub>l</sub>	_	_	-25	mA	V <sub>I</sub> = -2V
Output Current	I <sub>O(off)</sub>	_	_	-0.5	μΑ	$V_{CC} = -50V, V_{I} = 0V$
DC Current Gain	Gı	68	_	_	_	_
Gain-Bandwidth Product*	f <sub>T</sub>	_	200	_	MHz	V <sub>CE</sub> = -10V, I <sub>E</sub> = -50mA, f = 100MHz

<sup>\*</sup> Transistor - For Reference Only

Notes: 1. No purposefully added lead.

<sup>2. &</sup>quot;Green" devices, Halogen and Antimony Free, Diodes Inc's "Green" Policy can be found on our website at http://www.diodes.com

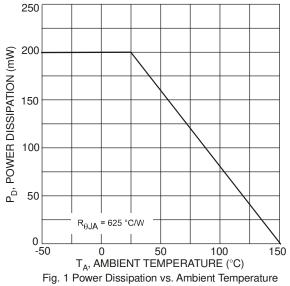


# Electrical Characteristics NPN Section Tr2 @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	$BV_CBO$	50			<b>V</b>	$I_C = 50\mu A$
Collector-Emitter Breakdown Voltage	$BV_CEO$	50			V	$I_C = 1mA$
Emitter-Base Breakdown Voltage	$BV_{EBO}$	5		_	V	$I_E = 50\mu A$
Collector Cutoff Current	I <sub>CBO</sub>	_		0.5	μΑ	$V_{CB} = 50V$
Emitter Cutoff Current	I <sub>EBO</sub>	1		0.5	μΑ	$V_{EB} = 4V$
Collector-Emitter Saturation Voltage	$V_{CE(SAT)}$			0.3	V	$I_{C}/I_{B} = 10mA / 1.0mA$
DC Current Transfer Ratio	$h_{FE}$	100	250	600		$I_C = 1mA$ , $V_{CE} = 5V$
Gain-Bandwidth Product (Note 3)	f <sub>T</sub>		250		MHz	$V_{CE} = 10V, I_E = -5mA, f = 100MHz$

3. Transistor - For Reference Only Notes:

### **Typical Curves - Tr2**



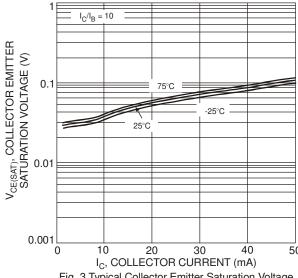


Fig. 3 Typical Collector Emitter Saturation Voltage vs. Collector Current

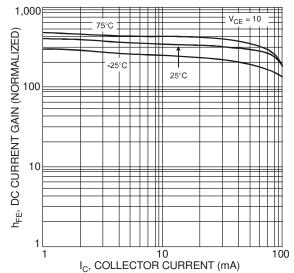


Fig. 2 Typical DC Current Gain vs. Collector Current

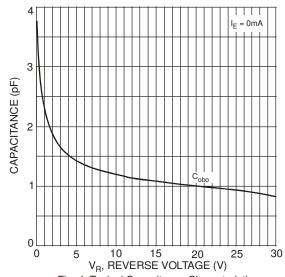
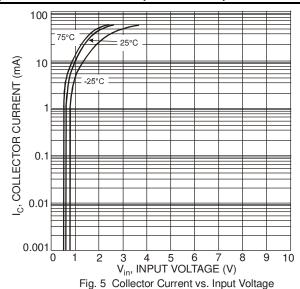
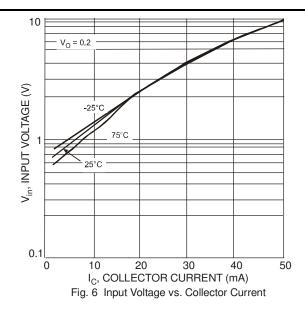


Fig. 4 Typical Capacitance Characteristics



# Typical Curves - Tr2 (continued)



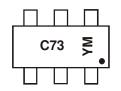


Ordering Information (Note 4)

Part Number	Case	Packaging
DIMD10A-7	SC-74R	3000/Tape & Reel

Notes: 4. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

### **Marking Information**

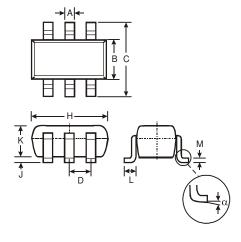


C73 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: S = 2005) M = Month (ex: 9 = September)

Date Code Key

- 410 0000 110,												
Year	2005	2006	2007	2008	2009	20	010	2011	2012	2013	2014	2015
Code	S	T	U	V	W	)	X	Υ	Z	Α	В	С
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

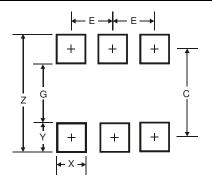
### **Package Outline Dimensions**



SC-74R									
Dim	Min	Max	Тур						
Α	0.35	0.50	0.38						
В	1.50	1.70	1.60						
С	2.70	3.00	2.80						
D	_	_	0.95						
H	2.90	3.10	3.00						
J	0.013	0.10	0.05						
K	1.00	1.30	1.10						
L	0.35	0.55	0.40						
М	0.10	0.20	0.15						
α	0°	8°	_						
All D	imensi	ons in	mm						



### **Suggested Pad Layout**



Dimensions	Value (in mm)
Z	3.20
G	1.60
Х	0.55
Υ	0.80
С	2.40
E	0.95

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